

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Original Patent

Patentee: Nguyen et al.
Patent No.: 5,710,461
Title: SRAM CELL FABRICATION WITH INTERLEVEL
DIELECTRIC PLANARIZATION
Issued: January 20, 1998
Docket No.: 93-C-078C1

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Reissue Application

Applicant: Nguyen et al.
Application No.:
Title: SRAM CELL FABRICATION
WITH INTERLEVEL
DIELECTRIC PLANARIZATION
Docket No.: 93-C-078C1-RE (1678-20)
Date: January 20, 2000

BOX REISSUE

Assistant Commissioner for Patents
Washington, DC 20231

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Signature

FIRST PRELIMINARY AMENDMENT

Sir:

Please amend the above-identified reissue application as follows: